ISO9001 & ISO14001 & TS16949 **CHILISIN ELECTRONICS CORP.**

RoHS & Halogen Free & REACH Compliance.

# SPECIFICATION FOR APPROVAL

**Customer：**

**Customer P/N:**

**Drawing No：**

**Quantity：** **0** **Pcs.** **Date：** **2017/7/14**

**Chilisin P/N：** **CPY201212T-100T-NP**

| SPECIFICATION ACCEPTED BY: | |
|---|---|
| COMPONENT ENGINEER | |
| ELECTRICAL ENGINEER | |
| MECHANICAL ENGINEER | |
| APPROVED | |
| REJECTED | |

奇力新電子股份有限公司
Chilisin Electronics Corp
No. 29, Alley 301, Tehhsin Rd.,
Hukou,Hsinchu 303, Taiwan
TEL：+886-3- 599-2646
FAX：+886-3- 599-9176
E-mail：sales@chilisin.com.tw
http：//www.chilisin.com.tw

東莞奇力新電子有限公司
Chilisin Electronics (Dongguan) Co., Ltd.
No. 78, Puxing Rd., Yuliangwei Administration Area,
Qingxi Town, Dongguan City, Guangdong,China
TEL：+86-769-8773-0251~3
FAX： +86-769-8773-0232
E-mail：cect@chilisin.com.tw

奇力新電子(河南)有限公司
Chilisin Electronics (Henan) Co., Ltd.
XiuWu Xian, industry gathering area
JiaoZuo, Henan China
Postal Code:454350
TEL:+86-391-717-0682
FAX:+86-391-717-0666

蘇州奇益新電子有限公司
SUZHOU QI YIXIN Electronics Co., Ltd.
No.143,Song Shan Rd., Suzhou New District,
Suzhou,China
Postal Code:215129
TEL:+86-512-6841-2350
FAX:+86-512-6841-2356
E-mail：suzhou@chilisin.com.tw

| Drawn by | Checked by | Approved by |
|---|---|---|
| **張瑞滿 Rammi** | **邱明傑 Joseph.Chiu** | **鍾瑞民 jacky.chung** |

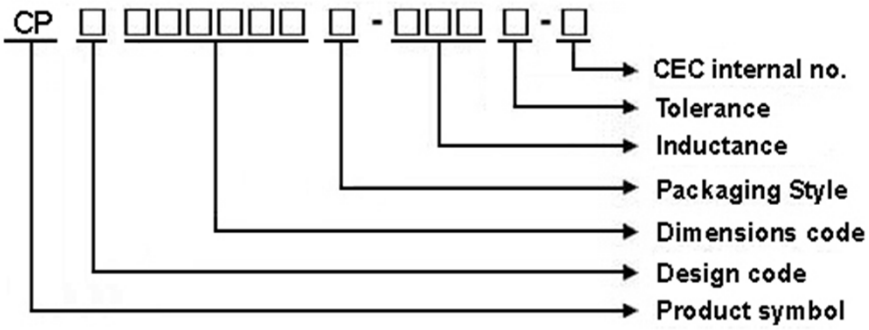
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

# CPY201212T Series Specification

## 1 Scope:

This specification applies to Multilayer Ferrite chip inductors

## 2 Part Numbering:




## 3 Rating:

Operating Temperature: －４０℃～１０５℃(Including self - temperature rise)

Storage Temperature: －４０℃～８５℃(after PCB)
－５℃～４０℃,Humidity ４０%～７０%(before PCB)

## 4 Marking:

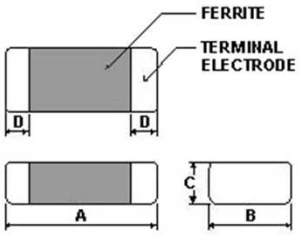
No Marking

## 5 Standard Testing Condition

| | Unless otherwise specified | In case of doubt |
|---|---|---|
| Temperature | Ordinary Temperature(15 to 35℃) | 20 to 30℃ |
| Humidity | Ordinary Humidity(25 to 85% RH) | 50 to 80 %RH |

# CPY201212T Series Specification

## 6 Configuration and Dimensions:




Dimensions in mm

| TYPE | CP201212 |
|---|---|
| A | 2.00±0.20 |
| B | 1.25±0.20 |
| C | 1.25±0.20 |
| D | 0.50±0.30 |

## 7 Electrical Characteristics:

| Part No. | Inductance (uH) | Test Freq. | RDC (Ω)Max. | Rated Current (mA)Max. | Tolerance (±%) |
|---|---|---|---|---|---|
| CPY201212T-100□-NP | 10 | 1 MHz,200 mV | 0.5 | 400 | 20,30 |

**NOTE: □-tolerance M=±20% / T=±30%**

1.Operating temperature range －４０℃～１０５℃(Including self - temperature rise)

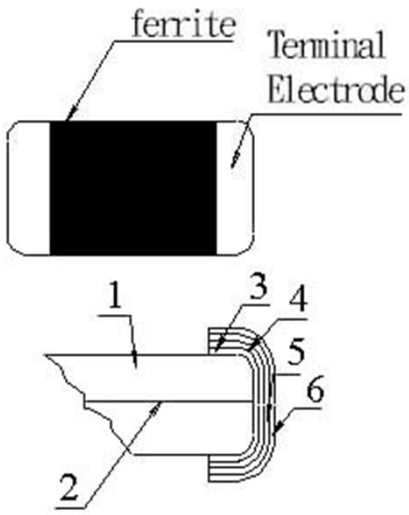
2.Rate Current : Applied the current to coils, the temperature rise shall not be more than 30℃

"-N" FOR COMPLETELY LEAD FREE TYPE(INCLUDING FERRITE BODY & SOLDER)

# CPY201212T Series Specification

## 8 CPY201212T Series

### 8.1 Construction:



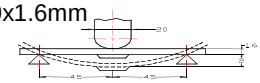

### 8.2 Material List:

| No | Part | Material |
|---|---|---|
| 1 | Ferrite Substance | NiO-CuO-ZnO-Ferrite |
| 2 | Silver electrode | Ag |
| 3 | Silver electrode | Ag |
| 4 | Cu plating | Cu |
| 5 | Ni plating | Ni |
| 6 | Sn plating | Sn |

# CPY201212T Series Specification

## 9 Reliability Of Ferrite Multilayer Chip Inductor

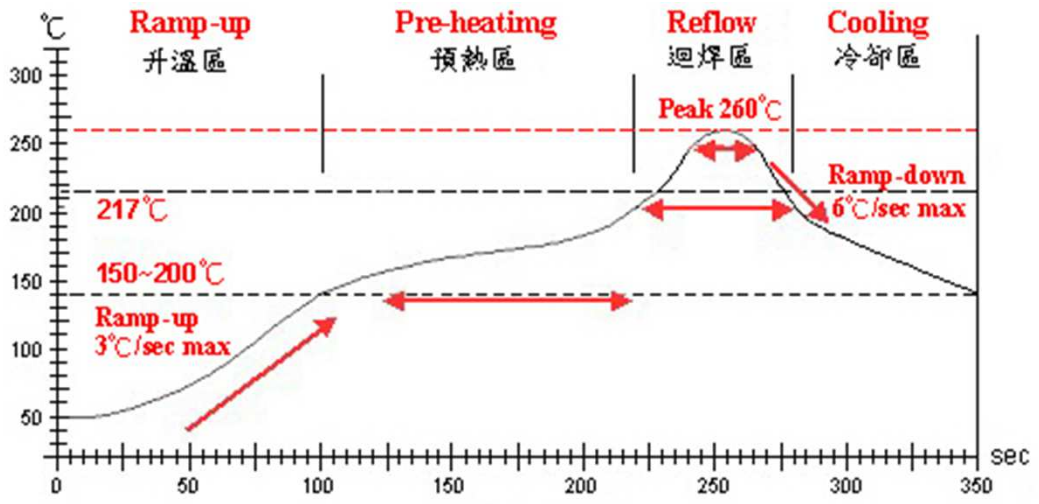
### 1-1.Mechanical Performance

| No | Item | Specification | Test Method |
|---|---|---|---|
| 1-1-1 | Flexure Strength | The forces applied on the right conditions must not damage the terminal electrode and the ferrite | Test device shall be soldered on the substrate<br>Substrate Dimension: 100x40x1.6mm<br>Deflection: 2.0mm<br>Keeping Time: 30sec<br>*For 100505, substrate dimension is 100x40x0.8mm<br>  |
| 1-1-2 | Vibration | | Test device shall be soldered on the substrate<br>Oscillation Frequency: 10 to 55 to 10Hz for 1min<br>Amplitude: 1.5mm<br>Time: 2hrs for each axis (X, Y & Z), total 6hrs |
| 1-1-3 | Resistance to Soldering Heat | Appearance: No damage<br>More than 75% of the terminal electrode should be covered with solder.<br>Inductance: within ±20% of initial value | Pre-heating: 150℃, 1min<br>Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)<br>Solder Temperature: 260±5℃<br>Immersion Time: 10±1sec |
| 1-1-4 | Solder ability | The electrodes shall be at least 95% covered with new solder coating | Pre-heating: 150℃, 1min<br>Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)<br>Solder Temperature: 245±5℃(Pb-Free)<br>Immersion Time: 4±1sec |

### 1-2.Environmental Performance

| No | Item | Specification | Test Method |
|---|---|---|---|
| 1-2-1 | Temperature Cycle | Appearance: No damage<br>Inductance:within±20% of initial value | One cycle:<br>Step / Temperature (℃) / Time (min)<br>1 / -40±3 / 30<br>2 / 25±2 / 3<br>3 / 105±3 / 30<br>4 / 25±2 / 3<br>Total: 100cycles<br>Measured after exposure in the room condition for 24hrs |
| 1-2-2 | Humidity Resistance | | Temperature: 40±2℃<br>Relative Humidity: 90 ~ 95% / Time: 1000hrs<br>Measured after exposure in the room condition for 24hrs |
| 1-2-3 | High Temperature Resistance | | Temperature: 85±3℃<br>Relative Humidity: 20%<br>Applied Current: Rated Current / Time: 1000hrs<br>Measured after exposure in the room condition for 24hrs |
| 1-2-4 | Low Temperature Resistance | | Temperature: -40±3℃<br>Relative Humidity: 0% / Time: 1000hrs<br>Measured after exposure in the room condition for 24hrs |

# CPY201212T Series Specification




Reflow profile

Lead-Free(LF) 標準溫度分析範圍 Refer to J-STD-020C

| 管制項目 Item. | 升溫區 Ramp-up | 預熱區 Pre-heatimg | 迴焊區 Reflow | Peak Temp | 冷卻區 Cooling |
|---|---|---|---|---|---|
| 溫度範圍 Temp.scope | R.T.~150℃ | 150℃~200℃ | 217℃ | 260±5℃ | Peak Temp.~150℃ |
| 標準時間 Time spec. | — | 60 ~ 180 sec | 60 ~ 150 sec | 20 ~ 40 sec | — |
| 實際時間 Time result | — | 75 ~ 100 sec | 90 ~ 120 sec | 20 ~ 35 sec | — |

NOTE :

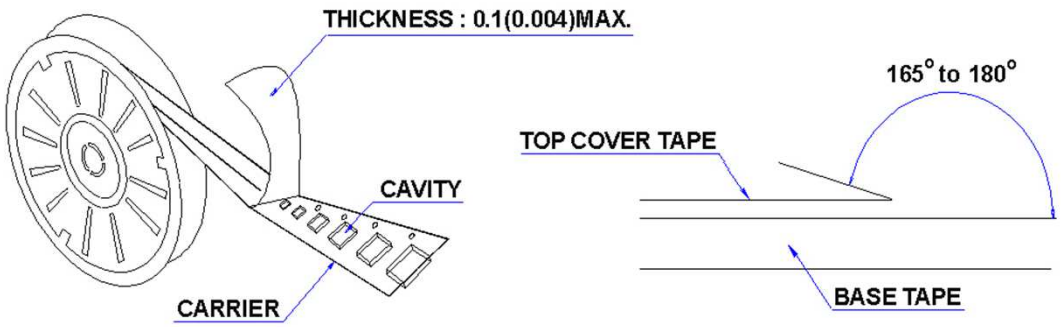
1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow

# CPY201212T Series Specification

## 10 Packaging:

### 10.1 Packaging -Cover Tape

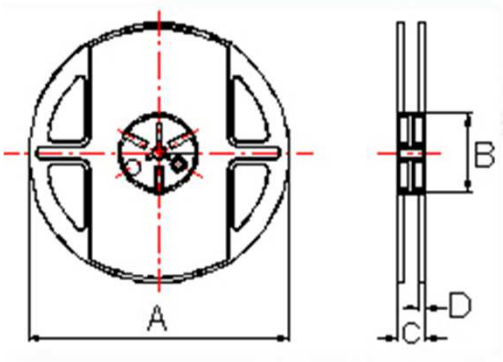
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.




### 10.2 Packaging Quantity

| TYPE | PCS/REEL |
|---|---|
| CP160808 | 4000 |
| CP201209 | 4000 |
| CP201212 | 3000 |
| CP321611 | 3000 |

### 10.3 Reel Dimensions



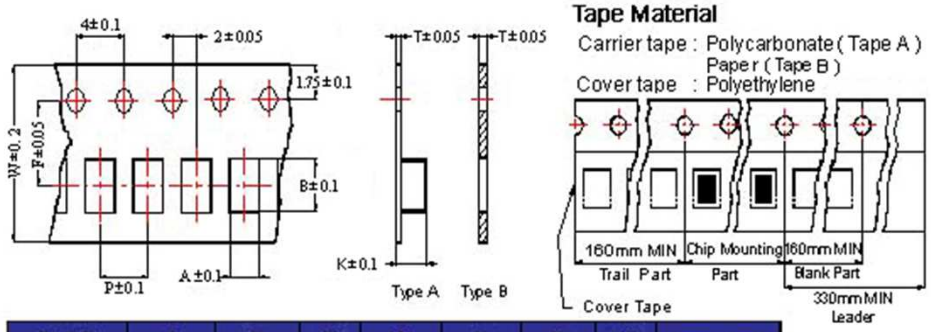

Dimensions in mm

| TYPE | A | B | C | D |
|---|---|---|---|---|
| CP Series | 178 | 60 | 12 | 1.5 |

# CPY201212T Series Specification

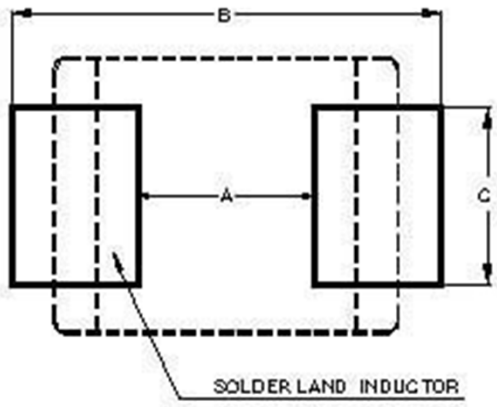
## 10 Packaging:

### 10.4 Tape Dimensions in mm




| TYPE | A | B | T | W | P | F | K | Tape Typ. |
|---|---|---|---|---|---|---|---|---|
| CP160808 | 1.05 | 1.85 | 0.95 | 8 | 4 | 3.5 | | B |
| CP201209 | 1.50 | 2.30 | 0.97 | 8 | 4 | 3.5 | | B |
| CP201212 | 1.35 | 2.25 | 0.22 | 8 | 4 | 3.5 | 1.35 | A |
| CP321611 | 1.88 | 3.50 | 0.22 | 8 | 4 | 3.5 | 1.27 | A |

## 11 Recommended Land Pattern:




Dimensions in mm

| TYPE | A | B | C |
|---|---|---|---|
| CP160808 | 0.7 ~ 0.8 | 1.8 ~ 2.0 | 0.6 ~ 0.8 |
| CP201209 | 1.0 ~ 1.2 | 2.6 ~4.0 | 1.0 ~ 1.2 |
| CP201212 | 1.0 ~ 1.2 | 2.6 ~4.0 | 1.0 ~ 1.2 |
| CP321611 | 2.0 | 4.2 ~ 5.2 | 1.2 |

## 12 Note:

1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
5. The moisture sensitivity level (MSL) of products is classified as level 1.

# CPY201212T Series Specification

## 13 Graph: CPY201212T-100T-NP